## 1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- Extremely low leakage current I<sub>R</sub> = 340 nA
- Average forward current: I<sub>F(AV)</sub> ≤ 3 A
- Reverse voltage: V<sub>R</sub> ≤ 60 V
- Low forward voltage V<sub>F</sub> = 600 mV
- · High power capability due to clip-bonding technology
- High temperature T<sub>i</sub> ≤ 175 °C
- Small and flat lead SMD plastic package
- AEC-Q101 qualified
- Capable for reflow and wave soldering

# 3. Applications

- · Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- · Reverse polarity protection
- · Low power consumption applications

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le 155$ °C; square wave	-	-	3	A
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C	-	-	60	V
V <sub>F</sub>	forward voltage	$I_F$ = 3 A; $t_p \le 300 \mu s$ ; δ ≤ 0.02; $T_j$ = 25 °C	-	600	670	mV
I <sub>R</sub>	reverse current	$V_R = 60 \text{ V}; t_p \le 300  \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}$	-	340	1000	nA



# 5. Pinning information

### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		к <b>.}</b> -А
2	Α	anode	1 2	sym001
			CFP5 (SOD128)	

<sup>[1]</sup> The marking bar indicates the cathode.

# 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package					
	Name	Description	Version			
PMEG6030ELP	CFP5	plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128			

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG6030ELP	DH

# 8. Limiting values

#### **Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	60	V
I <sub>F</sub>	forward current	δ = 1; T <sub>sp</sub> = 150 °C		-	4.2	Α
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{amb} \le 75$ °C; square wave	[1]	-	3	А
		$\delta$ = 0.5; f = 20 kHz; T <sub>sp</sub> $\leq$ 155 °C; square wave		-	3	А
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; square wave; $T_{j(init)}$ = 25 °C		-	70	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[2]	-	0.75	W
			[3]	-	1.25	W
			[1]	-	2.5	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

- [1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ιι ( <u>)</u> -α <i>)</i>	thermal resistance from		[1] [2]	-	-	200	K/W
	junction to ambient		[1] [3]	-	-	120	K/W
			[1] [4]	-	-	60	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[5]	-	-	12	K/W

<sup>[1]</sup> For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.

- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.

Nexperia PMEG6030ELP

#### 60 V, 3 A low leakage current Schottky barrier rectifier

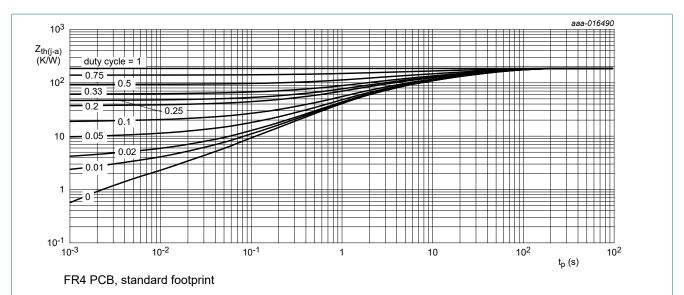
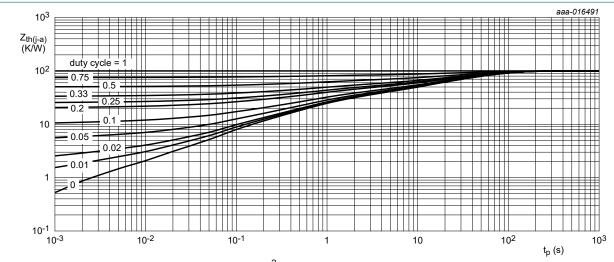


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

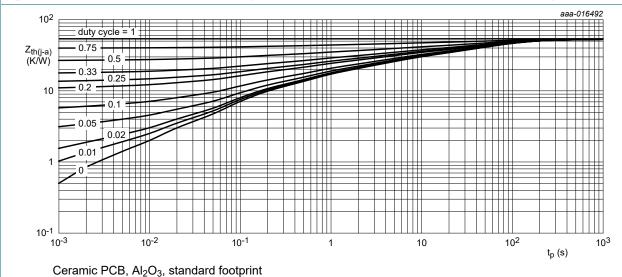


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

# 10. Characteristics

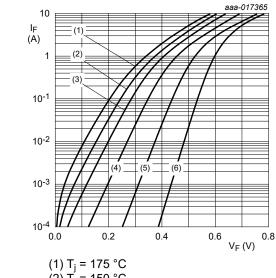
#### **Table 7. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>(BR)R</sub>	reverse breakdown voltage	$I_R$ = 1 mA; $t_p$ = 300 μs; δ = 0.02; $T_j$ = 25 °C	60	-	-	V
V <sub>F</sub>	forward voltage	$I_F$ = 0.1 A; $t_p \le 300 \mu s$ ; δ ≤ 0.02; $T_j$ = 25 °C	-	440	500	mV
		$I_F$ = 0.5 A; $t_p \le 300 \mu s$ ; δ = 0.02; $T_j$ = 25 °C	-	495	555	mV
		$I_F$ = 0.7 A; $t_p \le 300 \mu s$ ; δ ≤ 0.02; $T_j$ = 25 °C	-	505	565	mV
		$I_F$ = 1 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C	-	525	585	mV
		$I_F$ = 1.6 A; $t_p \le 300 \mu s$ ; δ ≤ 0.02; $T_j$ = 25 °C	-	550	620	mV
		$I_F$ = 2 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C	-	570	640	mV
		$I_F$ = 3 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C	-	600	670	mV
		$I_F$ = 3 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 125 °C	-	510	630	mV
I <sub>R</sub>	reverse current	$V_R$ = 10 V; $t_p \le 300 \mu s$ ; δ ≤ 0.02; $T_j$ = 25 °C	-	20	-	nA
		$V_R = 40 \text{ V}; t_p \le 300  \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}$	-	80	-	nA
		$V_R = 60 \text{ V}; t_p \le 300  \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}$	-	340	1000	nA
		$V_R$ = 60 V; $t_p \le 300$ μs; $δ \le 0.02$ ; $T_j$ = 125 °C	-	440	2100	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	315	-	pF
		V <sub>R</sub> = 4 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	190	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	125	-	pF
t <sub>rr</sub>	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$	-	12	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$	-	560	-	mV

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#### 60 V, 3 A low leakage current Schottky barrier rectifier



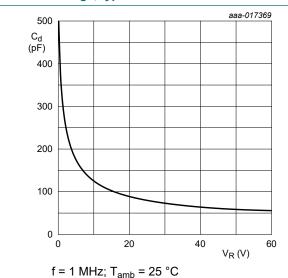
(2)  $T_i = 150 °C$ 

 $(3) T_i = 125 °C$ 

 $(4) T_i = 85 ^{\circ}C$ 

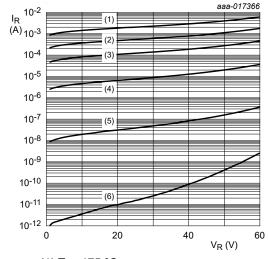
(5)  $T_i = 25 °C$ (6)  $T_i = -40 \, ^{\circ}\text{C}$ 

Fig. 4. Forward current as a function of forward voltage; typical values



Diode capacitance as a function of reverse Fig. 6.

voltage; typical values



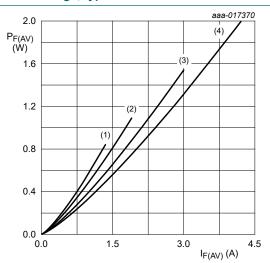
(1)  $T_j = 175 \,^{\circ}\text{C}$ (2)  $T_j = 150 \,^{\circ}\text{C}$ 

(3)  $T_i = 125 °C$ 

(4)  $T_i = 85$  °C

(5)  $T_i = 25$  °C (6)  $T_i = -40 \, ^{\circ}\text{C}$ 

Fig. 5. Reverse current as a function of reverse voltage; typical values



T<sub>i</sub> = 175 °C

 $(1) \delta = 0.1$ 

 $(2) \delta = 0.2$ 

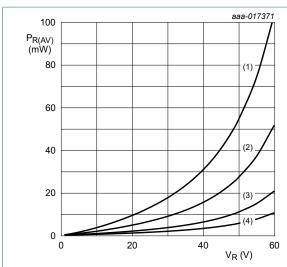
 $(3) \delta = 0.5$ 

 $(4) \delta = 1$ 

Fig. 7. Average forward power dissipation as a function of average forward current; typical values

**Nexperia** PMEG6030ELP

#### 60 V, 3 A low leakage current Schottky barrier rectifier



T<sub>i</sub> = 150 °C

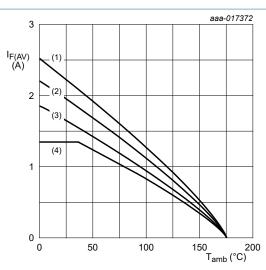
 $(1) \delta = 1 (DC)$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

 $(4) \delta = 0.1$ ; f = 20 kHz

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

 $T_i = 175 \,{}^{\circ}\text{C}$ 

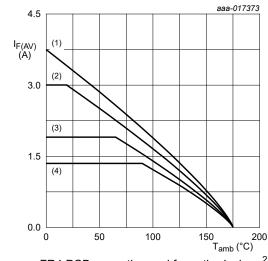
 $(1) \delta = 1$ ; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup> T<sub>i</sub> = 175 °C

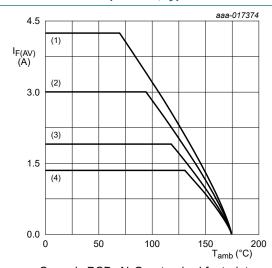
 $(1) \delta = 1$ ; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

T<sub>j</sub> = 175 °C

 $(1) \delta = 1; DC$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values

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### 60 V, 3 A low leakage current Schottky barrier rectifier

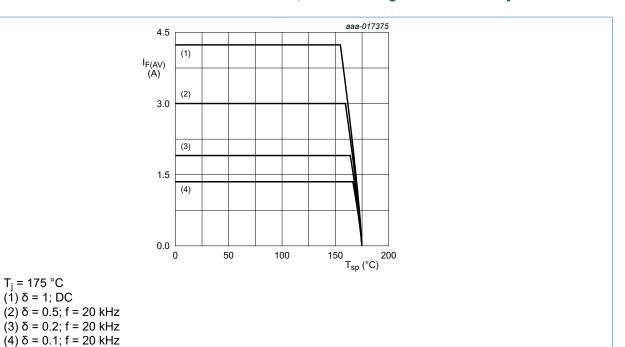
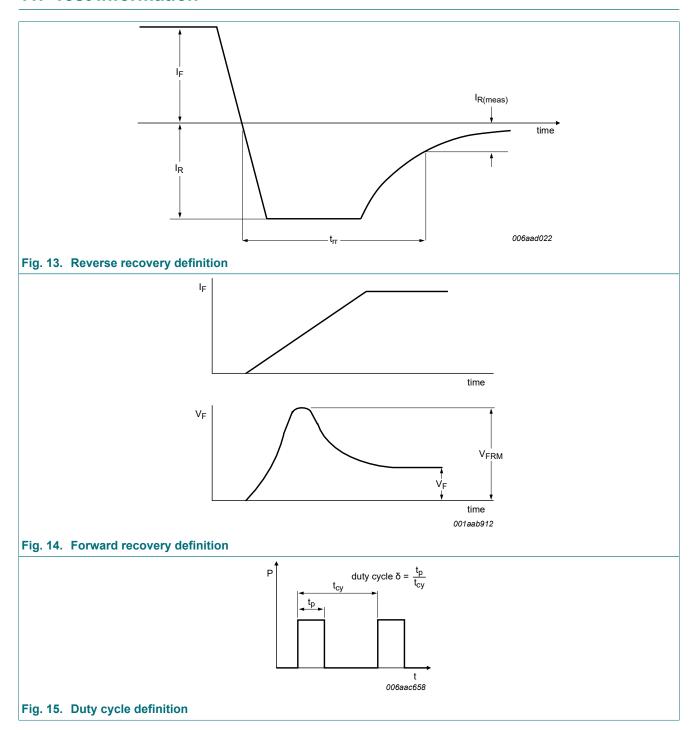


Fig. 12. Average forward current as a function of solder point temperature; typical values

T<sub>i</sub> = 175 °C  $(1) \delta = 1; DC$ 

### 11. Test information



The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

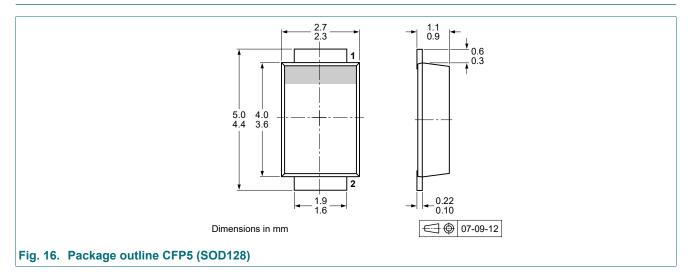
### **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

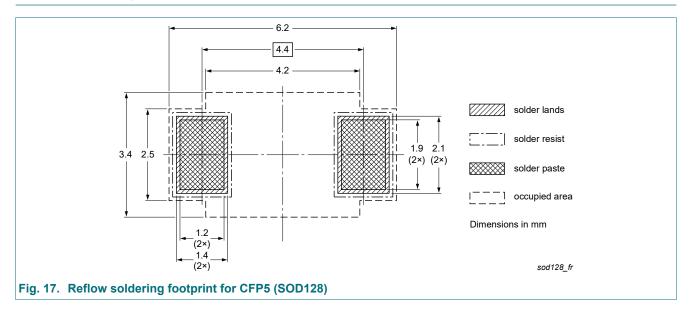
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60 V, 3 A low leakage current Schottky barrier rectifier

# 12. Package outline

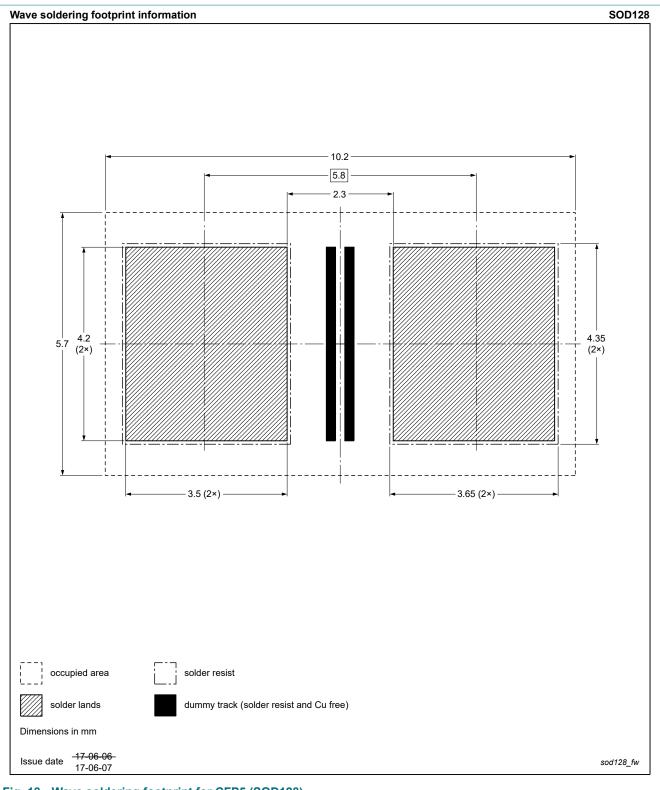


# 13. Soldering



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### 60 V, 3 A low leakage current Schottky barrier rectifier



# 14. Revision history

### **Table 8. Revision history**

Table 6. Revision history								
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
PMEG6030ELP v.3	20190228	Product data sheet	-	PMEG6030ELP v.2				
Modifications:	<ul> <li>Features and benefits: Capable for reflow and wave soldering added</li> <li>Soldering: Wave soldering footprint added</li> </ul>							
PMEG6030ELP v.2	20150507	Product data sheet	-	PMEG6030ELP v.1				
PMEG6030ELP v.1	20150320	Preliminary data sheet	-	-				

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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